MONOLITHIC TRIPLE FIXED DELAY LINE (SERIES 3D7303)



FEATURES PACKAGES

- All-silicon, low-power CMOS technology
- TTL/CMOS compatible inputs and outputs
- Vapor phase, IR and wave solderable
- Auto-insertable (DIP pkg.)
- · Low ground bounce noise
- Leading- and trailing-edge accuracy
- Delay range: 10 through 500ns
- Delay tolerance: 2% or 1.0ns
- Temperature stability: ±3% typical (0C-70C)
- Vdd stability: ±1% typical (4.75V-5.25V)
- Minimum input pulse width: 20% of total delay
- 14-pin DIP available as drop-in replacement for hybrid delay lines

I1 🗀	$1 \bigcirc 8$	□ VDD	11	\Box 1	\bigcirc_{14}	VDD
12	2 7	D 01	N/C	\Box_2	13	N/C
13 □	3 6	D 02	12	Дз	12	01
GND [4 5	□ O3	N/C	4	11	N/C
3D73	03M DIP		13	 5	10	O2
3D73	03H Gul		N/C	□6	9[N/C
	(300 Mil)	GND	<u> </u>	8	О3
1 2 3 GND	1 8 m 1 2 7 m 1 3 6 m 1 4 5 m	01 02	3D73 3D73 3D73	303G	DIP Gull-Wi Unused	
GIAD		. 05				• .

3D7303Z SOIC (150 Mil)

3D7303K Unused pin: removed (300 Mil)

FUNCTIONAL DESCRIPTION

The 3D7303 Triple Delay Line product family consists of fixed-delay CMOS integrated circuits. Each package contains three matched, independent delay lines. Delay values can range from 10ns through 500ns. The input is reproduced at the output without inversion, shifted in time as per the user-specified dash number. The 3D7303 is TTL- and CMOS-compatible, capable of driving ten 74LS-type loads, and features both rising- and falling-edge accuracy.

The all-CMOS 3D7303 integrated circuit has been designed as a reliable, economic alternative to hybrid TTL fixed delay lines. It is offered in a standard 8-pin auto-insertable DIP and a space saving

PIN DESCRIPTIONS

11 Delay Line 1 Input
12 Delay Line 2 Input
13 Delay Line 3 Input
O1 Delay Line 1 Output
O2 Delay Line 2 Output
O3 Delay Line 3 Output
VCC +5 Volts
CND Ground

GND Ground N/C No Connection

offered in a standard 8-pin auto-insertable DIP and a space saving surface mount 8-pin SOIC.

TABLE 1: PART NUMBER SPECIFICATIONS

PART NUMBER			DELAY	DELAY INPUT RESTRICTIONS				
DIP-8 3D7303M 3D7303H	SOIC-8 3D7303Z	DIP-14 3D7303 3D7303G	DIP-14 3D7303K	PER LI N E (ns)	Max Operating Frequency	Absolute Max Oper. Freq.	Min Operating Pulse Width	Absolute Min Oper. P.W.
-10	-10	-10	-10	10 ± 1.0	33.3 MHz	100.0 MHz	15.0 ns	5.0 ns
-15	-15	-15	-15	15 ± 1.0	22.2 MHz	100.0 MHz	22.5 ns	5.0 ns
-20	-20	-20	-20	20 ± 1.0	16.7 MHz	100.0 MHz	30.0 ns	5.0 ns
-25	-25	-25	-25	25 ± 1.0	13.3 MHz	83.3 MHz	37.5 ns	6.0 ns
-30	-30	-30	-30	30 ± 1.0	11.1 MHz	71.4 MHz	45.0 ns	7.0 ns
-40	-40	-40	-40	40 ± 1.0	8.33 MHz	62.5 MHz	60.0 ns	8.0 ns
-50	-50	-50	-50	50 ± 1.0	6.67 MHz	50.0 MHz	75.0 ns	10.0 ns
-100	-100	-100	-100	100 ± 2.0	3.33 MHz	25.0 MHz	150.0 ns	20.0 ns
-200	-200	-200	-200	200 ± 4.0	1.67 MHz	12.5 MHz	300.0 ns	40.0 ns
-300	-300	-300	-300	300 ± 6.0	1.11 MHz	8.33 MHz	450.0 ns	60.0 ns
-400	-400	-400	-400	400 ± 8.0	0.83 MHz	6.25 MHz	600.0 ns	80.0 ns
-500	-500	-500	-500	500 ± 10.0	0.67 MHz	5,00 MHz	750.0 ns	100.0 ns

NOTE: Any delay between 10 and 500 ns not shown is also available.

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APPLICATION NOTES

OPERATIONAL DESCRIPTION

The 3D7303 triple delay line architecture is shown in Figure 1. The individual delay lines are composed of a number of delay cells connected in series. Each delay line produces at its output a replica of the signal present at its input, shifted in time. The delay lines are matched and share the same compensation signals, which minimizes line-to-line delay deviations over temperature and supply voltage variations.

INPUT SIGNAL CHARACTERISTICS

The Frequency and/or Pulse Width (high or low) of operation may adversely impact the specified delay accuracy of the particular device. The reasons for the dependency of the output delay accuracy on the input signal characteristics are varied and complex. Therefore a **Maximum** and an **Absolute Maximum** operating input frequency and a **Minimum** and an **Absolute Minimum** operating pulse width have been specified.

OPERATING FREQUENCY

The Absolute Maximum Operating Frequency specification, tabulated in Table 1, determines the highest frequency of the delay line input signal that can be reproduced, shifted in time at the device output, with acceptable duty cycle distortion.

The Maximum Operating Frequency specification determines the highest frequency of the delay line input signal for which the output delay accuracy is guaranteed.

To guarantee the Table 1 delay accuracy for input frequencies higher than the Maximum Operating Frequency, the 3D7303 must be tested at the user operating frequency. Therefore, to facilitate production and device identification, the part number will include a custom reference designator identifying the intended frequency of operation. The programmed delay accuracy of the device is guaranteed, therefore, only at the user specified input frequency. Small input frequency variation about the selected frequency will only marginally impact the programmed delay accuracy, if at all. Nevertheless, it is strongly recommended that the engineering staff at DATA DELAY **DEVICES** be consulted.

OPERATING PULSE WIDTH

The Absolute Minimum Operating Pulse Width (high or low) specification, tabulated in Table 1, determines the smallest Pulse Width of the delay line input signal that can be reproduced, shifted in time at the device output, with acceptable pulse width distortion.

The **Minimum Operating Pulse Width** (high or low) specification determines the smallest Pulse Width of the delay line input signal for which the output delay accuracy tabulated in **Table 1** is guaranteed.

To guarantee the **Table 1** delay accuracy for input pulse width smaller than the **Minimum Operating Pulse Width**, the 3D7303 must be tested at the user operating pulse width. Therefore, to facilitate production and device identification, the **part number will include a**

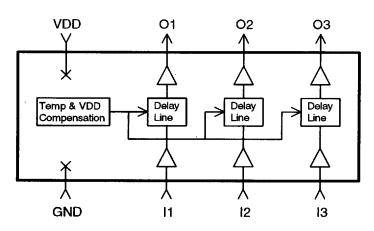


Figure 1: 3D7303 Functional Diagram

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APPLICATION NOTES (CONT'D)

custom reference designator identifying the intended frequency and duty cycle of operation. The programmed delay accuracy of the device is guaranteed, therefore, only for the user specified input characteristics. Small input pulse width variation about the selected pulse width will only marginally impact the programmed delay accuracy, if at all. Nevertheless, it is strongly recommended that the engineering staff at DATA DELAY DEVICES be consulted.

POWER SUPPLY AND TEMPERATURE CONSIDERATIONS

The delay of CMOS integrated circuits is strongly dependent on power supply and temperature. The monolithic 3D7303 programmable delay line utilizes novel and innovative compensation

circuitry to minimize the delay variations induced by fluctuations in power supply and/or temperature.

The thermal coefficient is reduced to 600 PPM/C, which is equivalent to a variation, over the 0C-70C operating range, of $\pm 3\%$ from the room-temperature delay settings and/or 1.0ns, whichever is greater. The power supply coefficient is reduced, over the 4.75V-5.25V operating range, to $\pm 1\%$ of the delay settings at the nominal 5.0VDC power supply and/or 2.0ns, whichever is greater. It is essential that the power supply pin be adequately bypassed and filtered. In addition, the power bus should be of as low an impedance construction as possible. Power planes are preferred.

DEVICE SPECIFICATIONS

TABLE 2: ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
DC Supply Voltage	V_{DD}	-0.3	7.0	٧	
Input Pin Voltage	$V_{!N}$	-0.3	V _{DD} +0.3	V	
Input Pin Current	1 _{IN}	-1.0	1.0	mA	25C
Storage Temperature	T _{STRG}	-55	150	С	
Lead Temperature	TLEAD	_	300	С	10 sec

TABLE 3: DC ELECTRICAL CHARACTERISTICS

(0C to 70C, 4.75V to 5.25V)

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
Static Supply Current*	I_{DD}		30	mA	
High Level Input Voltage	V _{IH}	2.0		V	
Low Level Input Voltage	V _{IL}		0.8	V	
High Level Input Current	lΗ		1	μΑ	$V_{IH} = V_{DD}$
Low Level Input Current	I _{IL}		1	μΑ	$V_{IL} = 0V$
High Level Output Current	I _{OH}	-4.0		mA	$V_{DD} = 4.75V$
					$V_{OH} = 2.4V$
Low Level Output Current	I _{OL}	4.0		mA	$V_{DD} = 4.75V$
					$V_{OL} = 0.4V$
Output Rise & Fall Time	T _R & T _F		2	ns	$C_{LD} = 5 pf$

^{*}I_{DD}(Dynamic) = 3 * C_{LD} * V_{DD} * F where: C_{LD} = Average capacitance load/line (pf)

F = Input frequency (GHz)

 $\label{eq:local_local} \mbox{Input Capacitance} = 10 \mbox{ pf typical} \\ \mbox{Output Load Capacitance} \mbox{ (C_{LD})} = 25 \mbox{ pf max} \\$



SILICON DELAY LINE AUTOMATED TESTING

TEST CONDITIONS

INPUT:

Ambient Temperature: 25°C ± 3°C Supply Voltage (Vcc): $5.0V \pm 0.1V$

Input Pulse:

 $High = 3.0V \pm 0.1V$

 $Low = 0.0V \pm 0.1V$

Source Impedance:

 50Ω Max.

Rise/Fall Time:

3.0 ns Max. (measured

Pulse Width: Period:

PW_{IN} = 1.25 x Total Delay PER_{IN} = 2.5 x Total Delay

between 0.6V and 2.4V)

OUTPUT:

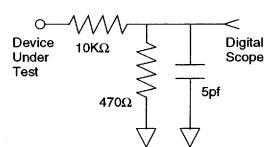
C_{load}:

R_{load}:

 $10K\Omega \pm 10\%$

5pf ± 10%

1.5V (Rising & Falling) Threshold:



NOTE: The above conditions are for test only and do not in any way restrict the operation of the device.

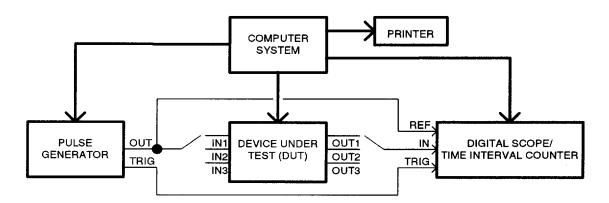


Figure 2: Test Setup

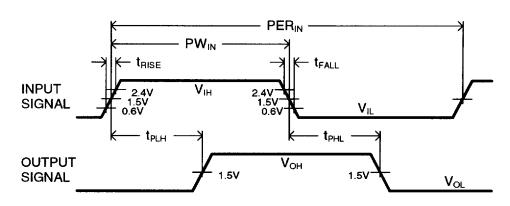


Figure 3: Timing Diagram

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